



AF/2827  
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8013-1147

PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

BOX AF

Hirokazu HONDA

Confirmation No. 7187

Serial No. 09/678,609

Group 2827

Filed October 4, 2000

Examiner D. Graybill

MULTILAYER INTERCONNECTION BOARD, SEMICONDUCTOR DEVICE HAVING THE SAME, AND METHOD OF FORMING THE SAME AS WELL AS METHOD OF MOUNTING THE SEMICONDUCTOR CHIP ON THE INTERCONNECTION BOARD

PETITION UNDER 37 CFR 1.97(d) (2) (ii)

Commissioner for Patents

Washington, D.C. 20231

Sir:

Applicants hereby request consideration of the Information Disclosure Statement filed under even date herewith.

Please charge the requisite 37 C.F.R. 1.17(p) fee of \$180.00 to Deposit Account No. 25-0120.

Respectfully submitted,

YOUNG & THOMPSON

By

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March 5, 2003

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